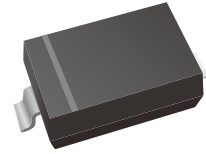


Schottky Barrier Diode

Features

- Low Forward Voltage
- Fast Switching
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case: SOD-123
- Polarity: Color band denotes cathode end
- Approx. Weight: 10.5mg



Ordering Information

Part Number	Marking	Shipping	Reel
LTS40W-TR3	43	3000PCS Tape&Reel	7 inches
LTS40W-TR12	43	12000PCS Tape&Reel	13 inches

Maximum Ratings ($T_a=25$ unless otherwise noted)

Parameter	Symbol	Value	Unit
DC Blocking Voltage	V_R		
Working Peak Reverse Voltage	V_{RWM}	40	V
Peak Repetitive Peak Reverse Voltage	V_{RRM}		
Forward continuous current	I_{FM}	200	mA
Non-Repetitive Peak Forward Surge Current @ $t=8.3ms$	I_{FSM}	600	mA
Power Dissipation	P_D	200	mW
Thermal Resistance Junction to Air ⁽¹⁾	R_{thJA}	500	°C/W
Thermal Resistance Junction to Case ⁽¹⁾	R_{thJC}	200	°C/W
Junction Temperature	T_j	125	°C
Storage Temperature Range	T_{stg}	-55 ~ +150	°C

Note 1: The data tested by surface mounted on a 1 inch FR-4 board with 10Z copper

Electrical Characteristics ($T_a=25$ unless otherwise Specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Reverse breakdown voltage	V_{BR}	$I_R=10\mu A$	40		V
Reverse voltage leakage current	I_R	$V_R=30V$		0.2	μA
Forward voltage	V_F	$I_F=1mA$ $I_F=40mA$		0.38 1.0	V
Diode capacitance	C_D	$V_R=0, f=1MHz$		5	pF
Reverse recovery time	t_{rr}	$I_{rr}=1mA, I_F=I_R=10mA$ $R_L=100\Omega$		5	ns



Characteristics Curves

Fig.1 Power Derating Curve

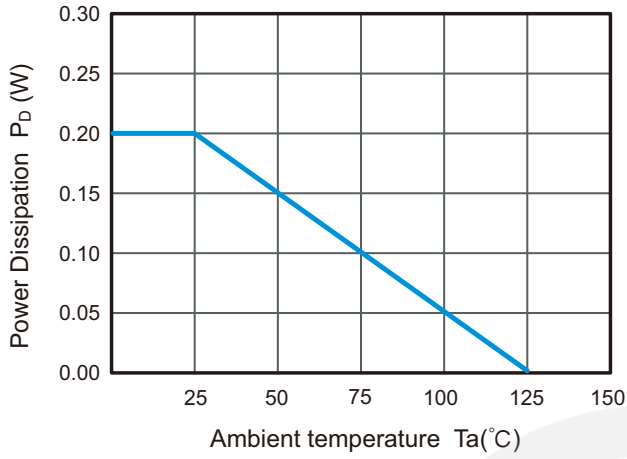


Fig.2 Typical Reverse Characteristics

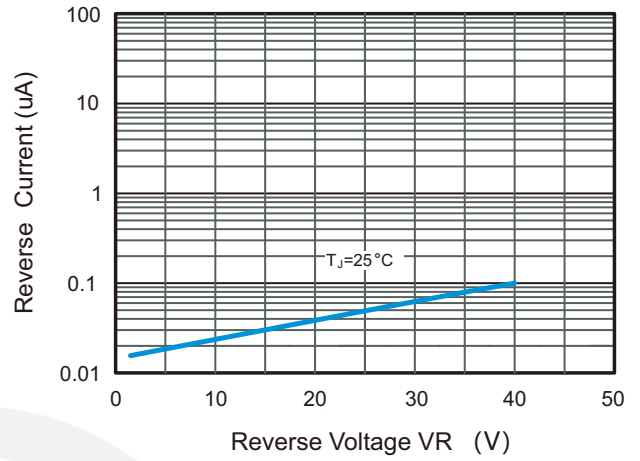


Fig.3 Forward Characteristics

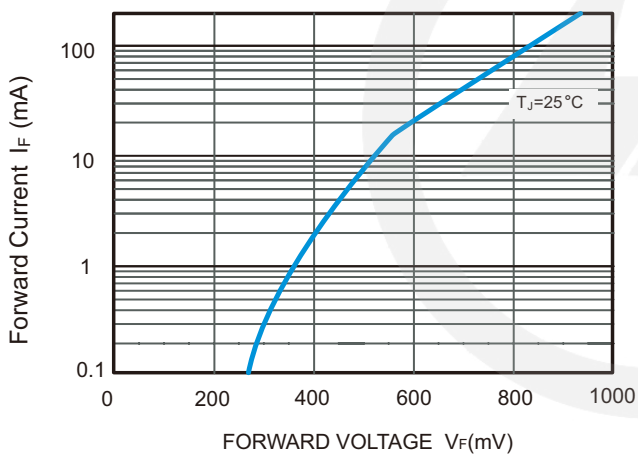
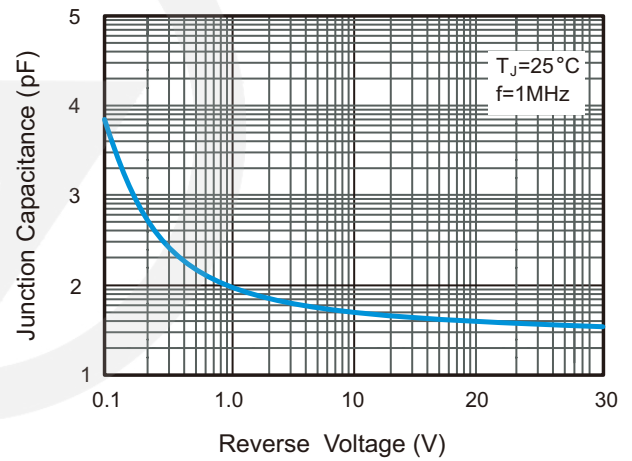
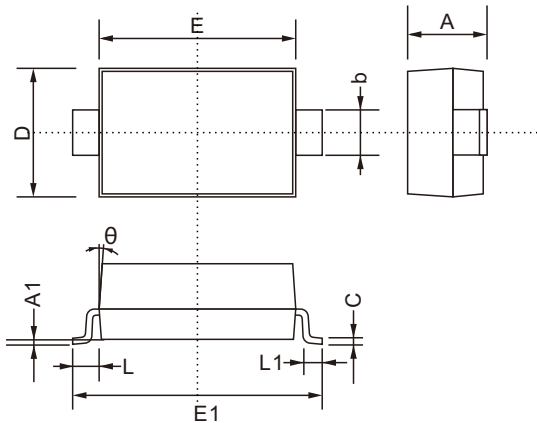


Fig.4 Typical Junction Capacitance



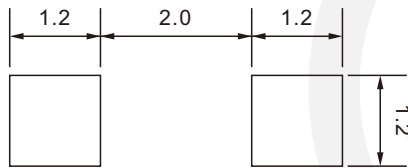
SOD-123 Package Outline

Unit: mm



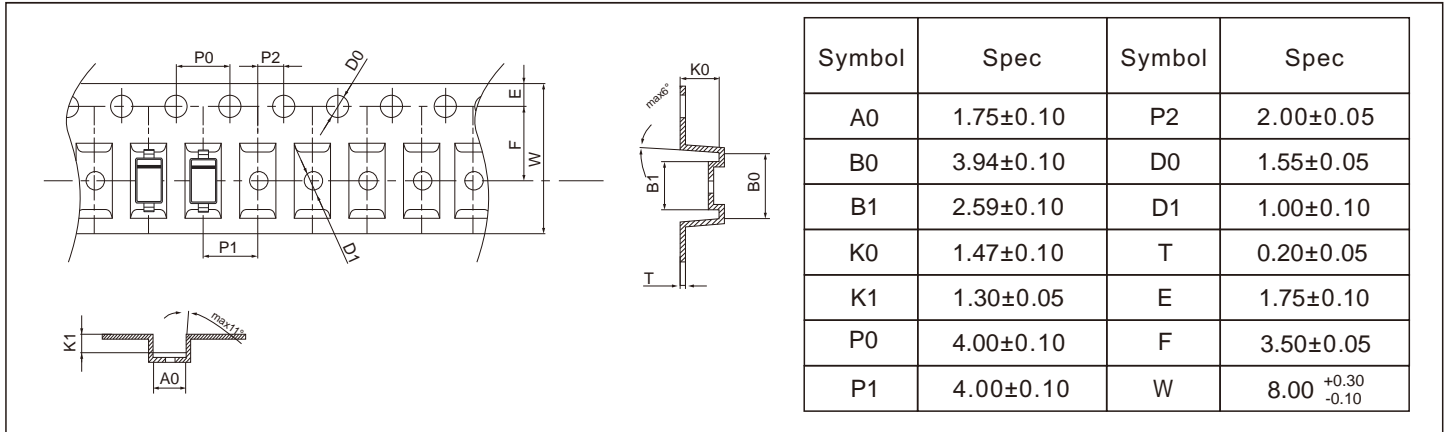
SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.900	1.300
A1	0.000	0.200
b	0.450	0.750
C	0.080	0.230
D	1.500	1.800
E	2.500	2.800
E1	3.550	3.900
L1	0.250	0.450
L	0.5REF	
θ	8°	

SOD-123 Suggested Pad Layout

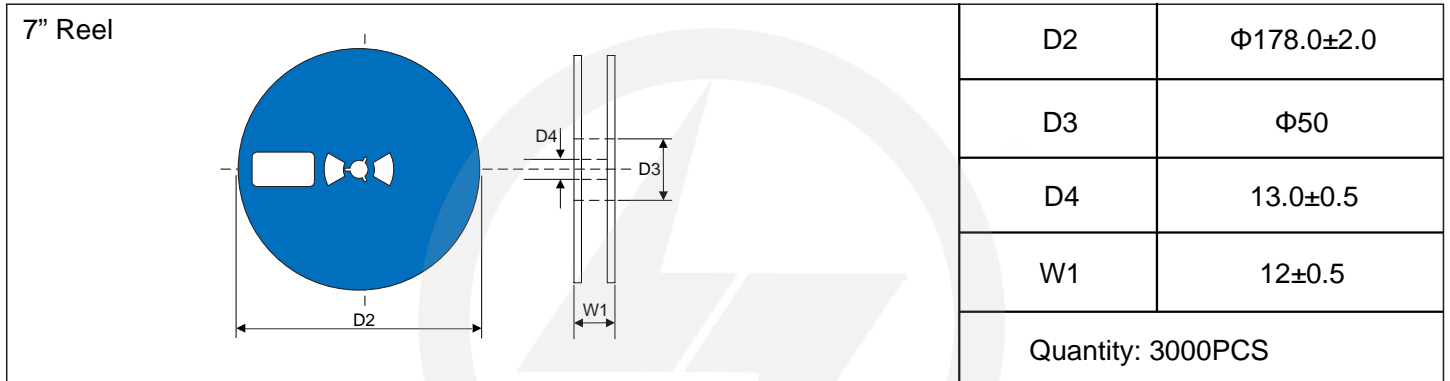


- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$
 3. The pad layout is for reference purpose only.

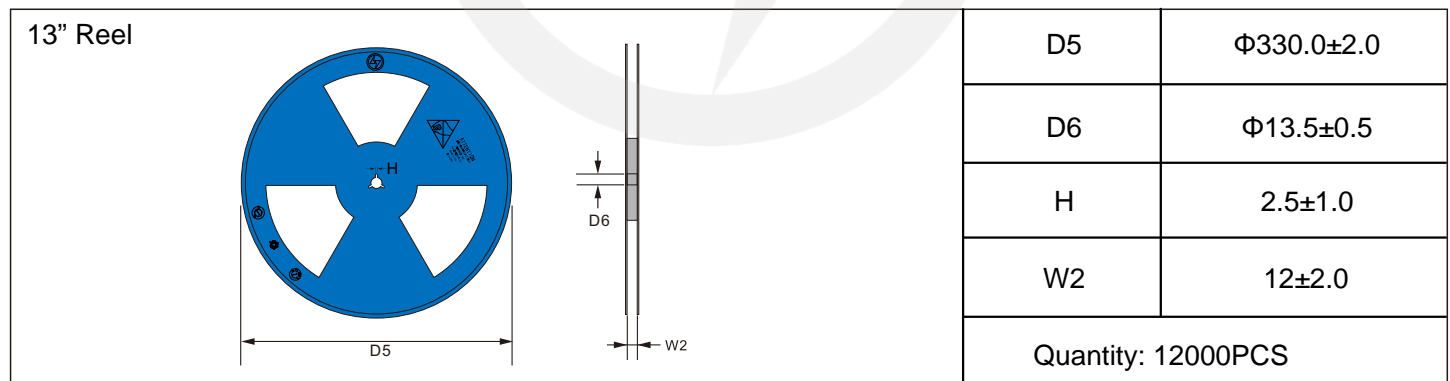
Carrier Tape Dimensions



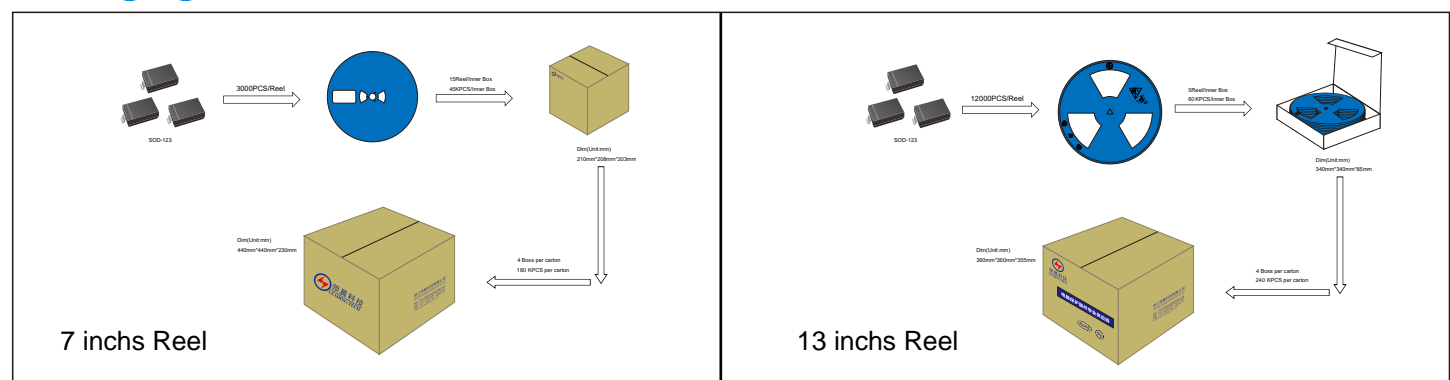
Reel Dimensions

Unit : mm


Reel Dimensions

Unit : mm


Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat	
-Temperature Min ($T_{S\ min}$)	150°C
-Temperature Max ($T_{S\ max}$)	200°C
-Time (min to max) (t_s)	60-180 seconds
$T_{S\ max}$ to T_L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T_L)	217°C
-Time (t_L)	60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision Content	Revision Reason	Revision Person	Note
01	2025.06.14	2025.06.14	3.0	New file	/	Ding	